

LM96080 System Hardware Monitor with 2-Wire Serial Interface

Check for Samples: LM96080

FEATURES

- Local Temperature Sensing
- 7 Positive Voltage Inputs with 10-bit Resolution
- 2 Programmable Fan Speed Monitoring Inputs
- 2.5 mV LSb and 2.56V Input Range
- Chassis Intrusion Detector Input
- WATCHDOG Comparison of All Monitored Values
- Separate Input to Show Status in Interrupt Status Register of Additional External Temperature Sensors Such as the LM26/27, LM56/57, LM73, or LM75
- I²C Serial Bus Interface Compatibility, Supports Standard Mode, 100 kbits/s, and Fast Mode, 400 kbits/s
- Shutdown Mode to Minimize Power Consumption
- Programmable RST_OUT/OS Pin: RST_OUT Provides a Reset Output; OS Provides an Interrupt Output Activated by an Overtemperature Shutdown Event
- Software and Pin Compatible with the LM80

APPLICATIONS

- Communications Infrastructure
- System Thermal and Hardware Monitoring for Servers
- Electronic Test Equipment and Instrumentation
- Office Electronics

KEY SPECIFICATIONS

- Total Unadjusted Error ±1 %FS (Max)
- Differential Non-Linearity ±1 Lsb (Max)
- Supply Voltage Range +3.0 V to +5.5 V
- Supply Current (Operating) 0.370 mA Typ
- Supply Current (Shutdown) 0.330 mA Typ
- ADC Resolution 10 Bits
- Temperature Resolution 0.5°C/0.0625°C
- Temperature Accuracy ±3°C (Max)

DESCRIPTION

LM96080, compatible to LM80, is a hardware monitor that contains a 10-bit delta-sigma ADC capable of measuring 7 positive voltages and local temperature. The LM96080 also measures the speed of two fans and includes other hardware monitoring on an I²C® interface. The LM96080 includes a sequencer that performs WATCHDOG window comparisons of all measured values and its interrupt outputs become active when any values exceed the programmed limits.

The LM96080 is especially suited to interface to both linear and digital temperature sensors. The 2.5 mV LSb (least significant bit) and 2.56 volt input range is ideal for accepting inputs from a linear sensor such as the LM94022. The BTI is used as an input from either digital or thermostat sensors such as LM73, LM75, LM56, LM57, LM26, LM27, LM26LV, or other LM96080.

The LM96080 supports Standard Mode (Sm, 100 kbits/s) and Fast Mode (Fm, 400 kbits/s) I²C interface modes of operation. LM96080 includes an analog filter on the I²C digital control lines that allows improved noise immunity and supports TIMEOUT reset function on SDA and SCL that prevents I²C bus lockup. Three I²C device address pins allow up to 8 parts on a single bus.

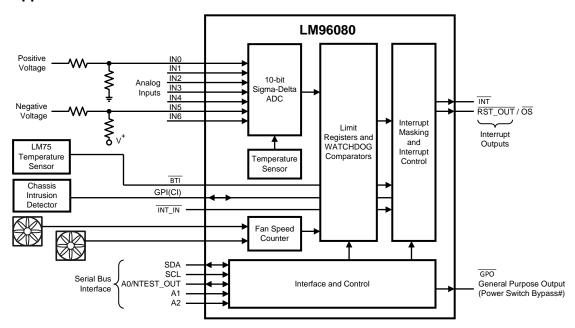
The LM96080's 3.0V to 5.5V supply voltage range, low supply current, and I²C interface make it ideal for a wide range of applications. Operation is ensured over the temperature range of (-40)°C \leq T_{A} \leq +125°C. The LM96080 is available in a 24-pin TSSOP package.

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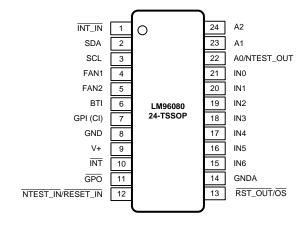
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Typical Application



Connection Diagram





PIN DESCRIPTIONS

| Pin Number | Pin Name(s) | ESD Structure | Type | Description |
|---------------|---------------------------------|------------------|----------------|--|
| 1 | ĪNT_IN | | Digital Input | Interrupt Input Bar. This is an active low input that propagates the INT_IN signal to the INT output of the LM96080. |
| 2 | SDA | | Digital I/O | Serial Bus Bidirectional Data. NMOS open-drain output. |
| 3 | SCL | | Digital Input | Serial Bus Clock. |
| 4-5 | FAN1, FAN2 | | Digital Inputs | Fan tachometer inputs. |
| 6 | ВТІ | | Digital Input | Board Temperature Interrupt driven by Overtemperature Shutdown (O.S.) outputs of additional temperature sensors such as LM75. This pin provides internal pull-up of 10 k Ω . |
| 7 | GPI (Chassis Intrusion) | | Digital I/O | General Purpose Input pin. GPI can be used as an additional active high interrupt input pin or as an active high input from an external circuit which latches a Chassis Intrusion event. |
| 8 | GND | | GROUND | Internally connected to all of the digital circuitry. |
| 9 | V+ | ESD Clamp | POWER | +3.0V to +5.5V power. Bypass with the parallel combination of 10 μ F (electrolytic or tantalum) and 0.1 μ F (ceramic) bypass capacitors. |
| 10 | ĪNT | | Digital Output | Non-Maskable Interrupt (Active High, PMOS, open-drain) or Interrupt Request (Active Low, NMOS, open-drain). Whenever INT_IN, BTI, or GPI interrupts, this output pin becomes active. |
| 11 | GPO (Power Switch Bypass) | | Digital Output | General Purpose Output pin is an active low NMOS open drain output intended to drive an external power PMOS for software power control or can be utilized to control power to a cooling fan. |

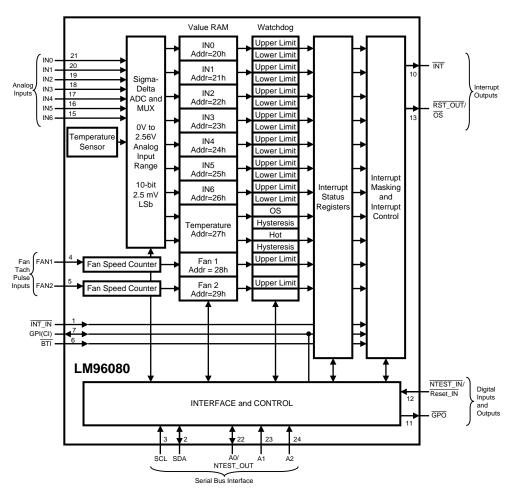


PIN DESCRIPTIONS (continued)

| Pin Number | Pin Name(s) | ESD Structure | Туре | Description |
|---------------|-----------------------|------------------|----------------|--|
| 12 | NTEST_IN/ RESET_IN | | Digital Input | An active-low input that enables NAND Tree board-level connectivity testing. Whenever NAND Tree connectivity is enabled, the LM96080 resets to its power on state. |
| 13 | RST_OUT/O | | Digital Output | This pin is an NMOS open drain output. RST_OUT provides a master reset to devices connected to this line. OS is dedicated to the temperature reading WATCHDOG. |
| 14 | GNDA | | GROUND | Internally connected to all analog circuitry. The ground reference for all analog inputs. This pin needs to be taken to a low noise analog ground plane for optimum performance. |
| 15-21 | IN6-IN0 | | Analog Inputs | 0V to 2.56V full scale range Analog Inputs. |
| 22 | A0/NTEST_O UT | | Digital I/O | The lowest order bit of the Serial Bus Address. This pin also functions as an output when doing a NAND Tree test. |
| 23-24 | A1-A2 | | Digital Inputs | The two highest order bits of the Serial Bus Address. |



Block Diagram





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.



Absolute Maximum Ratings(1)(2)(3)

| Supply Voltage (V ⁺) | | 6.0V | | | |
|--|-------------------|---|--|--|--|
| Voltage on SCL, SDA, RST_OUT/OS, FAN2 | (-0.3)V to +6.0V | | | | |
| Voltage on Other Pins | | (-0.3)V to (V ⁺ + 0.3V) and ≤ 6.0V | | | |
| (GND - GNDA) | | ±300 mV | | | |
| Input Current at Any Pin (4) | | ±5 mA | | | |
| Package Input Current ⁽⁴⁾ | | ±30 mA | | | |
| Maximum Junction Temperature (T _J r | nax) | 150°C | | | |
| ESD Susceptibility ⁽⁵⁾ | Human Body Model | 3000V | | | |
| | Machine Model | 300V | | | |
| | 1000V | | | | |
| Storage Temperature | (−65)°C to +150°C | | | | |
| For soldering specifications, see http://www.ti.com/lit/SNOA549 ⁽⁶⁾ | | | | | |

- (1) All voltages are measured with respect to GND, unless otherwise specified
- (2) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- (3) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (4) When the input voltage (V_{IN}) at any pin exceeds the power supplies (V_{IN}< (GND or GNDA) or V_{IN}>V +), the current at that pin should be limited to 5 mA. The 30 mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 5 mA to six pins. Parasitic components and/or ESD protection circuitry are shown in the Pin Descriptions table.
- (5) Human body model (HBM) is a charged 100 pF capacitor discharged into a 1.5 kΩ resistor. Machine model (MM), is a charged 200 pF capacitor discharged directly into each pin. Charged Device Model (CDM) simulates a pin slowly acquiring charge (such as from a device sliding down the feeder in an automated assembler) then rapidly being discharged.
- (6) Reflow temperature profiles are different for packages containing lead (Pb) than for those that do not...

Operating Ratings (1)(2)

| operaning maninge | |
|--|--|
| Supply Voltage (V ⁺) | +3.0V to +5.5V |
| Voltage on SCL, SDA, RST_OUT/OS, GPI (CI), GPO, NTEST_IN/RESET_IN, INT_IN, FAN1 and FAN2 | (−0.05)V to +5.5V |
| Voltage on Other Pins | (-0.05) V to $(V^+ + 0.05)$ V and ≤ 5.5 V |
| GND - GNDA | ≤ 100 mV |
| V _{IN} Voltage Range | $(-0.05)V$ to $(V^+ + 0.05)V$ |
| Temperature Range for Electrical Characteristics | $(-40)^{\circ}$ C $\leq T_{A} \leq +125^{\circ}$ C |
| Operating Temperature Range | $(-40)^{\circ}$ C $\leq T_{A} \leq +125^{\circ}$ C |
| Junction to Ambient Thermal Resistance (θ _{JA} ⁽³⁾) | |
| Package Number: PW | 95°C/W |
| | |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- (2) All voltages are measured with respect to GND, unless otherwise specified
- (3) The maximum power dissipation must be derated at elevated temperatures and is dictated by T_Jmax, θ_{JA} and the ambient temperature, T_A. The maximum allowable power dissipation at any temperature is P_D = (T_Jmax-T_A)/θ_{JA}.



DC Electrical Characteristics

The following specifications apply for +3.0 $V_{DC} \le V^+ \le$ +5.5 V_{DC} , IN0-IN6, $R_S = 25\Omega$, unless otherwise specified. **Boldface limits apply for T**_A = T_J = T_{MIN} to T_{MAX}; all other limits T_A = T_J = 25°C. (1)

| Symbol | Parameter | Conditions | Typical ⁽²⁾ | Limits ⁽³⁾ | Units (Limits) |
|---------------------|---|---|------------------------|-----------------------|------------------------|
| POWER S | SUPPLY CHARACTERISTICS | | Ш | 1 | |
| V ⁺ | Supply Voltage | | +3.3 +5.0 | +3.0 +5.5 | V (min) V(max) |
| l ⁺ | Supply Current (Interface Inactive). (See SUPPLY CURRENT (I+) for the I+ equation). | Round robin conversion, V ⁺ = 5.5V | 0.430 | 0.580 | mA (max) |
| | | Round robin conversion, V ⁺ = 3.8V | 0.370 | 0.520 | mA (max) |
| | | Shutdown mode, V ⁺ = 5.5V | 0.400 | 0.540 | mA (max) |
| | | Shutdown mode, V ⁺ = 3.8V | 0.330 | 0.480 | mA (max) |
| TEMPERA | ATURE-to-DIGITAL CONVERTER CHARACTERIS | TICS | | | |
| | Temperature Error | $(-40)^{\circ}C \le T_A \le +125^{\circ}C$ $(-25)^{\circ}C \le T_A \le +100^{\circ}C$ | | ±3 ±2 | °C (max) °C (max) |
| | Resolution | | | 0.0625 | °C (min) |
| ANALOG | -to-DIGITAL CONVERTER CHARACTERISTICS | | | | |
| n | Resolution (10 bits with full-scale at 2.56V) | | 2.5 | | mV |
| TUE | Total Unadjusted Error | See ⁽⁴⁾ | | ±1 | % (max) |
| DNL | Differential Non-Linearity | See ⁽⁵⁾ | | ±1 | LSb (max) |
| PSS | Power Supply Sensitivity | | ±0.05 | | % / V |
| t _C | Total Monitoring Cycle Time | See ⁽⁶⁾ | 728 | 662 810 | ms (min) ms (max) |
| MULTIPL | EXER/ADC INPUT CHARACTERISTICS | | • | | |
| R _{ON} | On Resistance | | 2 | 10 | kΩ (max) |
| I _{ON} | Input Current (On Channel Leakage Current) | | ±0.005 | | μΑ |
| I _{OFF} | Off Channel Leakage Current | | ±0.005 | | μΑ |
| FAN RPN | M-to-DIGITAL CONVERTER | | • | | |
| | Fan RPM Error | $(-40)^{\circ}C \le T_{A} \le +125^{\circ}C$ | | ±10 | % (max) |
| | Internal Clock Frequency | (–40)°C ≤ T _A ≤ +125°C | 22.5 | 20.2 24.8 | kHz (min) kHz (max) |
| | FAN1 and FAN2 Nominal Input | Divisor = 1, Fan Count = 153 ⁽⁷⁾ | 8800 | | RPM |
| | RPM (See FAN INPUTS) | Divisor = 2, Fan Count = 153 ⁽⁷⁾ | 4400 | | RPM |
| | | Divisor = 3, Fan Count = 153 ⁽⁷⁾ | 2200 | | RPM |
| | | Divisor = 4, Fan Count = 153 ⁽⁷⁾ | 1100 | | RPM |
| | Full-scale Count | | | 255 | (max) |
| DIGITAL | OUTPUTS: A0/NTEST_OUT, INT | | | | |
| V _{OUT(1)} | Logical "1" Output Voltage | I_{OUT} = +5.0 mA at V ⁺ = +4.5V, I_{OUT} = +3.0 mA at V ⁺ = +3.0V | | 2.4 | V (min) |
| V _{OUT(0)} | Logical "0" Output Voltage | I_{OUT} = +5.0 mA at V ⁺ = +4.5V, I_{OUT} = +3.0 mA at V ⁺ = +3.0V | | 0.4 | V (max) |

⁽¹⁾ Each input and output is protected by an ESD structure to GND, as shown in the Pin Descriptions table. Input voltage magnitude up to 0.3V above V⁺ or 0.3V below GND will not damage the LM96080. There are parasitic diodes that exist between some inputs and the power supply rails. Errors in the ADC conversion can occur if these diodes are forward biased by more than 50 mV. As an example, if V⁺ is 4.50 V_{DC}, input voltage must be ≤ 4.55 V_{DC}, to ensure accurate conversions.

⁽²⁾ Typicals are at $T_J = T_A = 25$ °C and represent most likely parametric norm.

⁽³⁾ Limits are specified to TI's AOQL (Average Outgoing Quality Level).

⁽⁴⁾ TUE (Total Unadjusted Error) includes Offset, Gain and Linearity errors of the ADC.

⁵⁾ Limit is Specified by Design.

Total Monitoring Cycle Time includes temperature conversion, 7 analog input voltage conversions and 2 tachometer readings. For more information on the conversion rates, refer to the description of bit 0, register 07h in REGISTERS AND RAM.

⁷⁾ The total fan count is based on 2 pulses per revolution of the fan tachometer output.



DC Electrical Characteristics (continued)

The following specifications apply for +3.0 $V_{DC} \le V^+ \le$ +5.5 V_{DC} , IN0-IN6, $R_S = 25\Omega$, unless otherwise specified. **Boldface limits apply for T**_A = T_J = T_{MIN} **to T**_{MAX}; all other limits T_A = T_J = 25°C. (1)

| Symbol | Parameter | Conditions | Typical ⁽²⁾ | Limits ⁽³⁾ | Units (Limits) |
|---------------------|---|---|------------------------|-----------------------|-------------------|
| OPEN DR | AIN OUTPUTS: \overline{GPO} , \overline{RST} OUT / \overline{OS} , \overline{GPI} | (CI) | | | |
| V _{OUT(0)} | Logical "0" Output Voltage | I_{OUT} = +5.0 mA at V ⁺ = +4.5V, I_{OUT} = +3.0 mA at V ⁺ = +3.0V | | 0.4 | V (min) |
| I _{OH} | High Level Output Current | $V_{OUT} = V^+$ | 0.005 | 1 | μA (max) |
| | RST_OUT/OS, GPI (CI) Pulse Width | | 22.5 | 10 | ms (min) |
| OPEN DR | AIN SERIAL BUS OUTPUT: SDA | | | | |
| $V_{OUT(0)}$ | Logical "0" Output Voltage | $I_{OUT} = +3.0 \text{ mA at V}^+ = +3.0 \text{V}$ | | 0.4 | V (min) |
| I _{OH} | High Level Output Current | V _{OUT} = V ⁺ | 0.005 | 1 | μA (max) |
| DIGITAL I | INPUTS: A0/NTEST_Out, A1-A2, BTI, GPI (| Chassis Intrusion), $\overline{	extsf{INT_IN}}$, and $\overline{	extsf{NTEST}}$ | _IN / Reset_IN | | |
| $V_{IN(1)}$ | Logical "1" Input Voltage | | | 2.0 | V (min) |
| V _{IN(0)} | Logical "0" Input Voltage | | | 8.0 | V (max) |
| VHYST | Hysteresis Voltage | V ⁺ = +3.3V | 0.23 | | V |
| | | V ⁺ = +5.5V | 0.33 | | V |
| SERIAL B | BUS INPUTS (SCL, SDA) | | | | |
| V _{IN(1)} | Logical "1" Input Voltage | | | 0.7 × V ⁺ | V (min) |
| V _{IN(0)} | Logical "0" Input Voltage | | | 0.3 × V ⁺ | V (max) |
| V_{HYST} | Hysteresis Voltage | V ⁺ = +3.3V | 0.67 | | V |
| | | V ⁺ = +5.5V | 1.45 | | V |
| FAN TAC | H PULSE INPUTS (FAN1, FAN2) | | | | |
| $V_{IN(1)}$ | Logical "1" Input Voltage | | | 0.7 × V ⁺ | V (min) |
| $V_{IN(0)}$ | Logical "0" Input Voltage | | | 0.3 × V ⁺ | V (max) |
| V_{HYST} | Hysteresis Voltage | V ⁺ = +3.3V | 0.35 | | V |
| | | V ⁺ = +5.5V | 0.5 | | V |
| ALL DIGI | TAL INPUTS Except for BTI | | | | |
| I _{IN(1)} | Logical "1" Input Current | $V_{IN} = V^{+}$ | -0.005 | -1 | μA (min) |
| $I_{IN(0)}$ | Logical "0" Input Current | $V_{IN} = 0 V_{DC}$ | 0.005 | 1 | μA (max) |
| C_{IN} | Digital Input Capacitance | | 20 | | pF |
| BTI Digita | al Input | | | | |
| I _{IN(1)} | Logical "1" Input Current | $V_{IN} = V^+$ | -1 | -10 | μA (min) |
| I _{IN(0)} | Logical "0" Input Current | $V_{IN} = 0 V_{DC}, V^{+} = +5.5 V$ | 1 | 2 | mA |
| C _{IN} | Digital Input Capacitance | | 20 | | pF |



AC Electrical Characteristics

The following specifications apply for +3.0 $V_{DC} \le V^+ \le$ +5.5 V_{DC} , unless otherwise specified. **Boldface limits apply for T_A = T_J = T_{MIN} to T_{MAX}**; all other limits T_A = T_J = 25°C. (1)

| Symbol | Parameter | Conditions | Typical ⁽²⁾ | Limits ⁽³⁾ | Units (Limits) |
|----------------------|---|------------|------------------------|-----------------------|----------------------|
| SERIAL B | US TIMING CHARACTERISTICS | | | | |
| t ₁ | SCL (Clock) Period | | | 2.5 100 | μs (min) μs (max) |
| t ₂ | Data In Setup Time to SCL High | | | 100 | ns (min) |
| t ₃ | Data Out Stable After SCL Low | | | 0 | ns (min) |
| t ₄ | SDA Low Setup Time to SCL Low (start) | | | 100 | ns (min) |
| t ₅ | SDA High Hold Time After SCL High (stop) | | | 100 | ns (min) |
| t _{TIMEOUT} | SCL or SDA time low for I ² C bus reset | | | 25 35 | ms (min) ms (max) |
| t _{RSDA} | Minimum NTEST_IN/Reset_IN rising edge to SDA falling edge | | 2 | | μs |
| t _{RSCL} | Minimum NTEST_IN/Reset_IN rising edge to SCL falling edge | | 13 | | μs |

- (1) Timing specifications are tested at the Serial Bus Input logic levels, V_{IN(0)} = 0.3 x V⁺ for a falling edge and V_{IN(1)} = 0.7 x V⁺ for a rising edge when the SCL and SDA edge rates are similar.
 (2) Typicals are at T_J= T_A= 25°C and represent most likely parametric norm.
- Reflow temperature profiles are different for packages containing lead (Pb) than for those that do not...

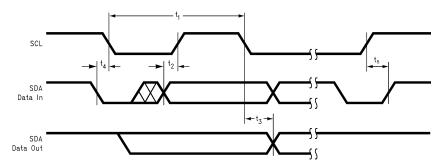
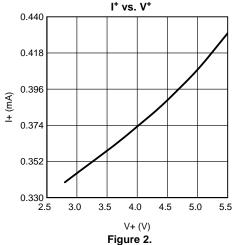


Figure 1. Serial Bus Timing Diagram



Typical Performance Characteristics

The following specifications apply for +3.0 $V_{DC} \le V^+ \le$ +5.5 V_{DC} , unless otherwise specified. **Boldface limits apply for T_A = T_J = T_{MIN} to T_{MAX};** all other limits $T_A = T_J = 25^{\circ}C.^{(1)}$



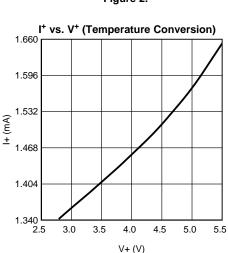
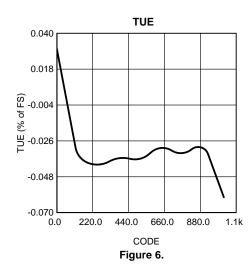
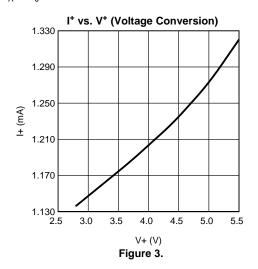
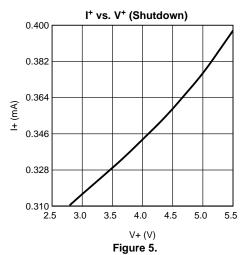
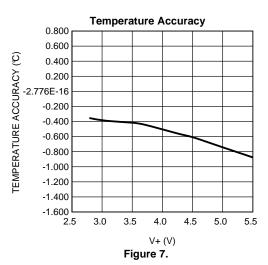


Figure 4.









(1) Timing specifications are tested at the Serial Bus Input logic levels, $V_{IN(0)} = 0.3 \times V^+$ for a falling edge and $V_{IN(1)} = 0.7 \times V^+$ for a rising edge when the SCL and SDA edge rates are similar.



FUNCTIONAL DESCRIPTION

GENERAL DESCRIPTION

The LM96080 provides 7 analog inputs, a temperature sensor, a delta-sigma ADC (Analog-to-Digital Converter), 2 fan speed counters, WATCHDOG registers, and a variety of inputs and outputs on a single chip. A two wire Serial Bus interface is also provided. The LM96080 can perform power supply, temperature and fan monitoring for a variety of computer systems. The LM96080 is pin and software backwards compatible with the LM80.

The LM96080 continuously converts analog inputs to 10-bit resolution with a 2.5 mV LSb (Least Significant bit) weighting, yielding input ranges of 0 to 2.56V. The Analog Inputs, IN0 - IN6, are intended to be connected to the several power supplies present in a typical communications infrastructure system. Temperature can be converted to a 9-bit or 12-bit two's complement word with resolutions of 0.5°C LSb or 0.0625°C LSb, respectively.

Fan inputs can be programmed to accept either fan failure indicator or tachometer signals. Fan failure signals can be programmed to be either active high or active low. Fan inputs measure the period of tachometer pulses from the the fans, providing a higher count for lower fan speeds. The fan inputs are digital inputs with transition levels according to the Fan Tach Pulse Inputs in the Electrical Characteristics table. Full scale fan counts are 255 (8-bit counter), which represent a stopped or very slow fan. Nominal speeds, based on a count of 153, are programmable from 1100 to 8800 RPM. Signal conditioning circuitry is included to accommodate slow rise and fall times.

The LM96080 provides a number of internal registers. These include:

- Configuration Register: Provides control and configuration.
- Interrupt Status Registers: Two registers to provide status of each WATCHDOG limit or Interrupt event.
- Interrupt Mask Registers: Allows masking of individual Interrupt sources, as well as separate masking for each of both hardware Interrupt outputs.
- Fan Divisor/RST_OUT/OS Registers: Bits 0-5 of this register contain the divisor bits for FAN1 and FAN2 inputs. Bits 6-7 control the function of the RST_OUT/OS output.
- OS Configuration/Temperature Resolution Register: The configuration of the OS (Overtemperature Shutdown) is controlled by the lower 3 bits of this register. Bit 3 enables 12-bit temperature conversions. Bits 4-7 reflect the lower four bits of the temperature reading for a 12-bit resolution.
- Conversion Rate Register: Controls the conversion rate of the round robin cycle to either continuous or 728 ms
- Voltage/Temperature Channel Disable Register: Allows voltage inputs and the local temperature conversion to be disabled.
- Value RAM: The monitoring results: temperature, voltages, fan counts, and Fan Divisor/RST_OUT/OS
 Register limits are all contained in the Value RAM. The Value RAM consists of a total of 32 bytes. The first 10
 bytes are all of the results, the next 20 bytes are the Watchdog Register limits, and the last two bytes are at
 the upper locations for Manufacturers ID and Device Stepping/Die Revision ID.

The LM96080 is compatible with Standard Mode (Sm, 100 kbits/s) and Fast Mode (Fm, 400 kbits/s) I²C interface modes of operation. LM96080 includes an analog filter on the I²C digital control lines that allows improved noise immunity and supports TIMEOUT reset function on SDA and SCL that prevents I²C bus lockup. Three address pins, A0 - A2, allow up to 8 parts on a single bus.

When enabled, the LM96080 starts by cycling through each measurement in sequence, and it continuously loops through the sequence based on the Conversion Rate Register (address 07h) setting. Each measured value is compared to values stored in WATCHDOG, or Limit Registers (addresses 2Ah - 2Dh). When the measured value violates the programmed limit, the LM96080 will set a corresponding Interrupt in the Interrupt Status Registers (addresses 01h - 02h).

Two output Interrupt lines, $\overline{\text{INT}}$ and $\overline{\text{RST_OUT/OS}}$, are available. $\overline{\text{INT}}$ is fully programmable with masking of each Interrupt source, and masking of each output. $\overline{\text{RST_OUT/OS}}$ is dedicated to the temperature reading WATCHDOG registers. In addition, the Fan Divisor register has control bits to enable or disable the hardware Interrupts.

Additional digital inputs are provided for daisy chaining the Interrupt output pin, $\overline{\text{INT}}$. This is done by connecting multiple external temperature sensors (i.e. LM75 or LM73) to the BTI (Board Temperature Interrupt) input and/or the GPI (Chassis Intrusion) input. The Chassis Intrusion input is designed to accept an active high signal from an external circuit that latches, such as when the cover is removed from the computer.



INTERFACE

Internal Registers of the LM96080

Table 1. The internal registers and their corresponding internal LM96080 address are as follows:

| Register | LM96080 Internal Address (Hex) | Power on Value (Binary) | Notes |
|--|-----------------------------------|----------------------------|---|
| Configuration Register | 00h | 0000 1000 | |
| Interrupt Status Register 1 | 01h | 0000 0000 | |
| Interrupt Status Register 2 | 02h | 0000 0000 | |
| Interrupt Mask Register 1 | 03h | 0000 0000 | |
| Interrupt Mask Register 2 | 04h | 0000 0000 | |
| Fan Divisor/RST_OUT/OS Register | 05h | 0001 0100 | FAN1 and FAN2 divisor = 2 (count of 153 = 4400 RPM) |
| OS/ Configuration/ Temperature Resolution Register | 06h | 0000 0001 | |
| Conversion Rate Register | 07h | 0000 0000 | |
| Voltage/Temperature Channel Disable Register | 08h | 0000 0000 | Allows voltage monitoring inputs to be disabled |
| Value RAM | 20h - 29h | Indeterminate | Input and FAN readings |
| Value RAM | 2Ah - 3Dh | Indeterminate | Limit Registers |
| Value RAM | 3Eh | 0000 0001 | Manufacturer's ID |
| Value RAM | 3Fh | 0000 1000 | Stepping/Die Revision ID |

Serial Bus Interface/Serial Bus Timings

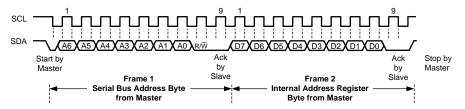


Figure 8. Internal Address Register Set Only

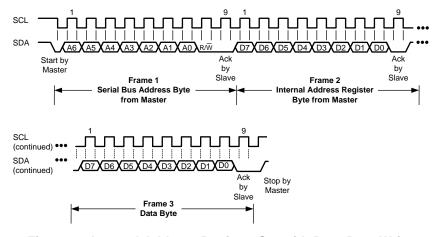


Figure 9. Internal Address Register Set with Data Byte Write



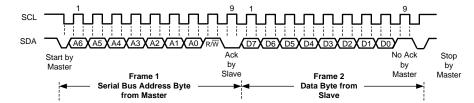


Figure 10. Single Byte Read from Register with Preset Internal Address Register

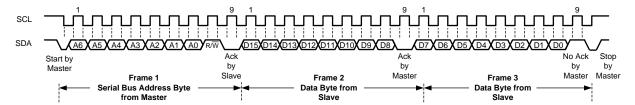


Figure 11. Double Byte Read from Register with Preset Internal Address Register

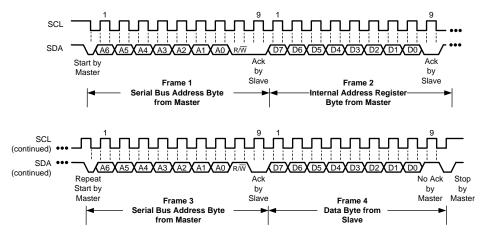


Figure 12. Single Byte Read from Register with Internal Address Set using a Repeat Start

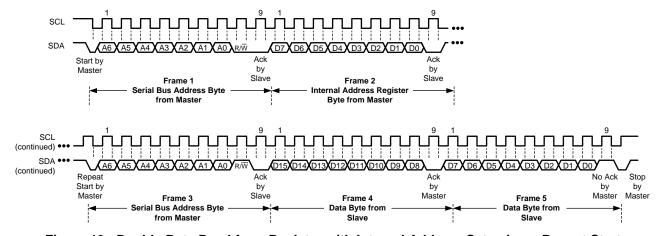


Figure 13. Double Byte Read from Register with Internal Address Set using a Repeat Start

The Serial Bus control lines include the SDA (serial data), SCL (serial clock), and A0-A2 (address) pins. The LM96080 can only operate as a slave. The SCL line only controls the serial interface, all other clock functions within LM96080 such as the ADC and fan counters are done with a separate asynchronous internal clock.



When using the Serial Bus Interface, a write will always consists of the LM96080 Serial Bus Interface Address byte, followed by the Internal Address Register byte, then the data byte.

There are two cases for a read:

- 1. If the Internal Address Register is known to be at the desired Address, simply read the LM96080 with the Serial Bus Interface Address byte, followed by the data byte read from the LM96080.
- 2. If the Internal Address Register value is unknown, write to the LM96080 with the Serial Bus Interface Address byte, followed by the Internal Address Register byte. Then restart the Serial Communication with a Read consisting of the Serial Bus Interface Address byte, followed by the data byte read from the LM96080.

The default power on Serial Bus address for the LM96080 is 0101(A2)(A1)(A0) binary, where A0-A2 are the Serial Bus Address.

All of the combinations of communications supported by the LM96080 are depicted in the Serial Bus Interface Timing Diagrams as shown in Figure 13.

USING THE LM96080

Power On

When power is first applied, the LM96080 performs a "power on reset" on several of its registers. The power on condition of registers is shown in Table 1. Registers whose power on values are not shown have power on conditions that are indeterminate (this includes the value RAM and WATCHDOG limits). In most applications, usually the first action after power-on would be to write WATCHDOG limits into the Value RAM.

Resets

Configuration Register INITIALIZATION bit (address 00h, bit 7) accomplishes the same function as power on reset. The Value RAM conversion results (addresses 20h - 29h) and Value RAM WATCHDOG limits (addresses 2Ah - 3Dh) are not reset and will be indeterminate immediately after power on. If the Value RAM contains valid conversion results and/or Value RAM WATCHDOG limits have been previously set, they will not be affected by the Configuration Register INITIALIZATION (except for addresses 3Eh and 3Fh). Power on reset or Configuration Register INITIALIZATION bit clear or initialize the following registers (the initialized values are shown in Table 1):

- 1. Configuration Register
- 2. Interrupt Status Register 1
- 3. Interrupt Status Register 2
- 4. Interrupt Mask Register 1
- 5. Interrupt Mask Register 2
- 6. Fan Divisor/RST_OUT/OS Register
- 7. OS Configuration/Temperature Resolution Register
- 8. Conversion Rate Register
- 9. Voltage/Temperature Channel Disable Register
- 10. Value RAM Registers (only addresses 3Eh and 3Fh)

Configuration Register INITIALIZATION is accomplished by setting bit 7 of the Configuration Register (address 00h) high. This bit automatically clears after being set.

The LM96080 can be reset to its "power on state" by taking NTEST_IN/Reset_IN pin low for at least 50 ns.

The time it takes for $\overline{\text{NTEST_IN}/\text{Reset_IN}}$ rising edge to SDA falling edge is at least t_{RSDA} , and for $\overline{\text{NTEST_IN}/\text{Reset_IN}}$ rising edge to SCL falling edge is at least t_{RSCL} . Refer to the AC Electrical Characteristics for more information on t_{RSDA} and t_{RSCL} .



Using the Configuration Register

The Configuration Register (address 00h) provides control for the LM96080. At power on, the ADC is stopped and INT_Clear (bit 3) is asserted, clearing the INT and RST_OUT/OS hardwire outputs. The Configuration Register starts and stops the LM96080, enables and disables INT outputs, clears and sets GPI (CI) and GPO I/O pins, initiates reset pulse on RST_OUT/OS pin, and provides the reset function described in the AC Electrical Characteristics section.

Bit 0 of the Configuration Register, START, controls the monitoring loop of the LM96080. Setting bit 0 low stops the LM96080 monitoring loop and puts the LM96080 in shutdown mode, reducing power consumption. Serial Bus communication is possible with any register in the LM96080 although activity on these lines will increase consumption current. Taking bit 0 high starts the monitoring loop, described in more detail subsequently.

Bit 1 of the Configuration Register, $\overline{\text{INT}}$ Enable, enables the $\overline{\text{INT}}$ Interrupt hardwire output when this bit is taken high.

Bit 2 of the Configuration Register, $\overline{\text{INT}}$ Polarity Select, defines whether the $\overline{\text{INT}}$ pin is NMOS or PMOS open drain

Bit 3, INT_Clear, clears the INT output when taken high. The LM96080 monitoring function will stop until bit 3 is taken low. The content of the Interrupt Status Registers (addresses 01h - 02h) will not be affected.

Bit 4, $\overline{\text{RESET}}$, when taken high, will initiate a 10 ms RESET signal on the $\overline{\text{RST_OUT/OS}}$ output when $\overline{\text{OS}}$ Pin Enable (address 05h, bit 6) = 0 and $\overline{\text{RST}}$ Enable (address 05h, bit 7) = 1.

When bit 5, Chassis Clear, is taken high, the GPI (Chassis Intrusion) pin is driven low for 10 ms.

Bit 6 of the configuration register, $\overline{\text{GPO}}$, sets or clears the $\overline{\text{GPO}}$ output. This pin can be used in software power control by activating an external power control MOSFET.

Starting Conversions

Start the monitoring function (Analog inputs, temperature, and fan speeds) in the LM96080 by writing to the Configuration Register and setting INT_Clear (bit 3) low and Start (bit 0) high. The LM96080 then performs a round-robin monitoring of all analog inputs, temperature, and fan speed inputs. The sequence of items being monitored corresponds to locations in the Value RAM (except for the Temperature reading) as follows:

- 1. Temperature
- 2. IN0
- 3. IN1
- 4. IN2
- 5. IN3
- 6. IN4
- 7. IN5
- 8. IN6
- 9. Fan 1
- 10. Fan 2

Reading Conversion Results

The conversion results are available in the Value RAM (addresses 20h - 29h). Conversions can be read at any time and will provide the result of the last conversion. If a conversion is in progress while a communication is started, that conversion will be completed, and the internal register(s) will not be updated until the communication is complete.

A typical sequence of events upon power on of the LM96080 would consist of:

- 1. Set WATCHDOG Limits
- 2. Set Interrupt Masks
- 3. Start the LM96080 monitoring process



ANALOG INPUTS

The 10-bit ADC has a 2.5 mV ($2.56/2^{10}$) LSb , yielding a 0V to 2.5575V (2.56 - 1 LSb) input range. This is true for all analog inputs. In most monitoring applications, these inputs would most often be connected to power supplies. The $2.5, 3.3, \pm 5$ and ± 12 volt inputs should be attenuated with external resistors to any desired value within the input range. Care should be taken not to exceed V⁺ at any time.

A typical application, such as is shown in Figure 14, might select the input voltage divider to provide 1.9V at the analog inputs of the LM96080. This is sufficiently high for good resolution of the voltage, yet leaves headroom for upward excursions from the supply of about 25%. To simplify the process of resistor selection, set the value of R2 first. Select a value for R2 or R4 between 10 k Ω and 100 k Ω . This is low enough to avoid errors due to input leakage currents yet high enough to protect both the inputs under overdrive conditions as well as minimize loading of the source. Then select R1 or R3 to provide a 1.9V input as show in Figure 14.

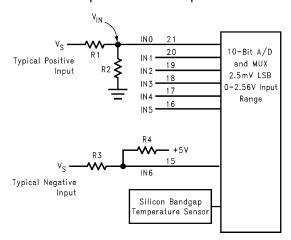


Figure 14. Input Examples. Resistor values shown in table provide approximately 1.9V at the analog inputs.

R1 or R3 R2 or R4 Voltage Measure-Voltage ments at **Analog Inputs** (V_S) (ADC code 760) +2.5V $23.7 k\Omega$ 75 kΩ +1.9V +3.3V 22.1 kΩ 30 kΩ +1.9V +5.0V 24 kΩ $14.7 \text{ k}\Omega$ +1.9V +12V 160 kΩ 30.1 kΩ +1.9V -12V 160 kΩ 35.7 kΩ +1.9V -5V $36 \text{ k}\Omega$ $16.2 \text{ k}\Omega$ +1.9V

Table 2. V_{IN} = 1.9V for Different R Values

For positive input voltages, the equation for calculating R1 is as follows:

$$R1 = [(V_S - V_{IN}) / V_{IN}] R2$$
 (1)

For negative input voltages, the equation for calculating R3 is as follows:

$$R3 = [(V_S - V_{IN}) / (V_{IN} - 5V)] R4$$
 (2)

External resistors should be included to limit input currents to the values given in the ABSOLUTE MAXIMUM RATINGS for Input Current At Any Pin. Inputs with the attenuator networks will usually meet these requirements. If it is possible for inputs without attenuators to be turned on while LM96080 is powered off, additional resistors of about 10 $k\Omega$ should be added in series with the inputs to limit the input current.



SUPPLY CURRENT (I+)

The measured supply current (I⁺) in the Electrical Characteristics are only for the round robin conversion and the shutdown mode at a certain supply voltage. To calculate the supply current I⁺ in the round robin mode at different supply voltages, use the equation below.

$$\frac{I + = (1293 \times I^{+}_{TEMP}) + (1116 \times 7 \times I^{+}_{VOLTAGE}) + (253037 \times I^{+}_{SHUTDOWN})}{262,142}$$
(3)

The I⁺_{TEMP}, I⁺_{VOLTAGE}, and I⁺_{SHUTDOWN} values can be obtained from the plots shown in Typical Performance Characteristics.

LAYOUT AND GROUNDING

Analog inputs will provide best accuracy when referred to the AGND pin or a supply with low noise. A separate, low-impedance ground plane for analog ground, which provides a ground point for the voltage dividers and analog components, will provide best performance but is not mandatory. Analog components such as voltage dividers should be located physically as close as possible to the LM96080.

The power supply bypass, a parallel combination of 10 μ F (electrolytic or tantalum) and 0.1 μ F (ceramic) bypass capacitors connected between V⁺, pin 9, and ground, should also be located as close as possible to the LM96080.

FAN INPUTS

Inputs are provided for signals from fans equipped with tachometer outputs. These are logic-level inputs set according to the Fan Tach Pulse Inputs in the Electrical Characteristics table. Signal conditioning in the LM96080 accommodates the slow rise and fall times typical of fan tachometer outputs. The maximum input signal range is 0 to +5.5V. In the event these inputs are supplied from fan outputs which exceed 0 to +5.5V, either resistive division or diode clamping must be included to keep inputs within an acceptable range. R2 is selected so that it does not develop excessive error voltage due to input leakage. R1 is selected based on R2 to provide a minimum input of 2V and a maximum of 5.5V. R1 should be as low as possible to provide the maximum possible input up to 5.5V for best noise immunity. Alternatively, use a shunt reference or zener diode to clamp the input level.

If fans can be powered while the power to the LM96080 is off, the LM96080 inputs must be protected to meet the Absolute Maximum Ratings section. In most cases, open collector outputs with pull-up resistors inherently limit this current. If this maximum current could be exceeded, either a larger pull up resistor should be used or resistors connected in series with the fan inputs.

The Fan Inputs gate an internal 22.5 kHz oscillator for one period of the Fan signal into an 8-bit counter (maximum count = 255). The default divisor is set to 2 (choices are 1, 2, 4, and 8) providing a nominal count of 153 for a 4400 RPM fan with two pulses per revolution. Typical practice is to consider 70% of normal RPM a fan failure, at which point the count will be 219.

Determine the fan count according to:

$$Count = \frac{1.35 \times 10^6}{RPM \times Divisor}$$
 (4)

For example, if the frequency of the tachometer were 150 Hz, the RPM would be 4,500 [RPM = (freq) \times (60 seconds/min) / (2 pulses/revolution)]. Since the default divisor is 2, the count would be 150 according to the equation above.

Note that Fan 1 and Fan 2 Divisors are programmable via the Fan Divisor/RST_OUT/OS Register (address 05h).

FAN1 and FAN2 inputs can also be programmed to be level sensitive interrupt inputs.

Fans that provide only one pulse per revolution would require a divisor set twice as high as fans that provide two pulses, thus maintaining a nominal fan count of 153. Therefore, the divisor should be set to 4 for a fan that provides 1 pulse per revolution with a nominal RPM of 4400.



Alternatives for Fan Inputs

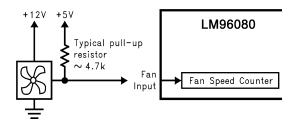


Figure 15. Fan with Tach Pull-Up to +5V

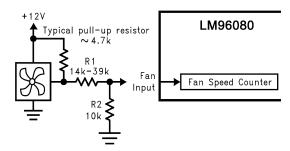


Figure 16. Fan with Tach Pull-Up to +12V, or Totem-Pole Output and Resistor Attenuator

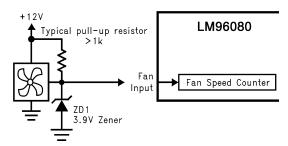


Figure 17. Fan with Tach Pull-Up to +12V and Diode Clamp

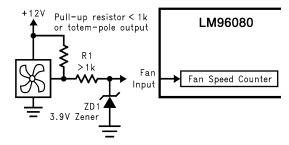


Figure 18. Fan with Strong Tach Pull-Up or Totem Pole Output and Diode Clamp

The table below shows example calculation for Count with different divisor and frequency. Counts are based on 2 pulses per revolution tachometer outputs.

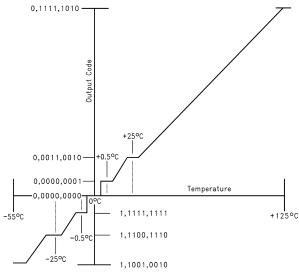
| RPM | Time per Revolution | Counts for "Divide by 2" | Comments |
|------|---------------------|--------------------------|-------------|
| | | (Default) in Decimal | |
| 4400 | 13.64 ms | 153 counts | Typical RPM |
| 3080 | 19.48 ms | 219 counts | 70% RPM |
| 2640 | 22.73 ms | 255 counts | 60% RPM |
| | | (maximum counts) | |

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| Mode Select | Nominal RPM | Time per Revolution | Counts for the | 70% RPM | Time per Revolution |
|-------------|-------------|---------------------|------------------------|---------|---------------------|
| | | | Given Speed in Decimal | | for 70% RPM |
| Divide by 1 | 8800 | 6.82 ms | 153 | 6160 | 9.74 ms |
| Divide by 2 | 4400 | 13.64 ms | 153 | 3080 | 19.48 ms |
| Divide by 4 | 2200 | 27.27 ms | 153 | 1540 | 38.96 ms |
| Divide by 8 | 1100 | 54.54 ms | 153 | 770 | 77.92 ms |

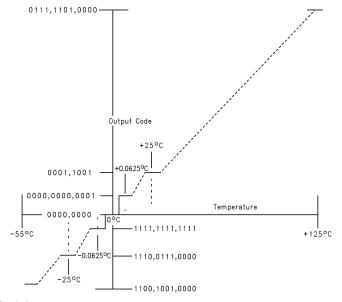
TEMPERATURE MEASUREMENT SYSTEM

The LM96080 delta-V_{BE} type temperature sensor and sigma-delta ADC perform 9-bit or a 12-bit two's-complement conversions of the temperature. An 8-bit digital comparator is also incorporated that compares the readings to the user-programmable Hot and Overtemperature setpoints, and Hysteresis values.



(Non-Linear Scale for Clarity)

Figure 19. 9-bit Temperature-to-Digital Transfer Function



(Non-Linear Scale for Clarity)

Figure 20. 12-bit Temperature-to-Digital Transfer Function



Temperature Data Format

Temperature data can be read from the Temperature Reading Register (address 27h). Temperature limits can be read from and written to the Hot Temperature, Hot Temperature Hysteresis, \overline{OS} Temperature, and \overline{OS} Temperature Hysteresis Limit Registers (addresses 38h - 3Bh). These limits are also referred to as T_{hot} , T_{hot} , T_{hot} , T_{os} , and T_{os} hyst respectively. Each limit is represented by an 8-bit, two's complement word with an LSb (Least Significant Bit) equal to 1°C:

| Temperature | Digital Output | | | |
|-------------|----------------|-----|--|--|
| | Binary | Hex | | |
| +125°C | 0111 1101 | 7Dh | | |
| +25°C | 0001 1001 | 19h | | |
| +1.0°C | 0000 0001 | 01h | | |
| +0°C | 0000 0000 | 00h | | |
| -1.0°C | 1111 1111 | FFh | | |
| −25°C | 1110 0111 | E7h | | |
| −55°C | 1100 1001 | C9h | | |

By default, Temperature Reading Register is represented by a 9-bit two's complement digital word with the LSb having a resolution of 0.5°C:

| Temperature | Digital Output | | |
|-------------|----------------|-------|--|
| | Binary | Hex | |
| +125°C | 0 1111 1010 | 0 FAh | |
| +25°C | 0 0011 0010 | 0 32h | |
| +1.5°C | 0 0000 0011 | 0 03h | |
| +0°C | 0 0000 0000 | 0 00h | |
| −0.5°C | 1 1111 1111 | 1 FFh | |
| −25°C | 1 1100 1110 | 1 CEh | |
| −55°C | 1 1001 0010 | 1 92h | |

Temperature Register data can also be represented by a 12-bit two's complement digital word with a LSb of 0.0625°C:

| Temperature | Digital Outpu | ıt |
|-------------|----------------|-------|
| | Binary | Hex |
| +125°C | 0111 1101 0000 | 7 D0h |
| +25°C | 0001 1001 0000 | 1 90h |
| +1.0°C | 0000 0001 0000 | 0 10h |
| +0.0625°C | 0000 0000 0001 | 0 01h |
| 0°C | 0000 0000 0000 | 0 00h |
| (-0.0625)°C | 1111 1111 1111 | F FFh |
| (−1.0)°C | 1111 1111 0000 | F F0h |
| (-25)°C | 1110 0111 0000 | E 70h |
| (−55)°C | 1100 1001 0000 | C 90h |



When using a single byte read, the 8 MSbs of the Temperature reading can be found at Value RAM (address 27h). The remainder of the Temperature reading can be found in the OS Configuration/Temperature Resolution Register (address 06h), bits 4-7. In 9-bit format, bit 7 is the only valid bit. In addition, all 9 or 12 bits can be read using a double byte read at register address 27h.

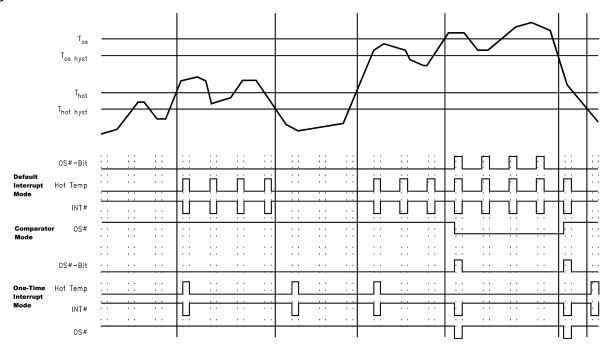
Temperature Interrupts

There are four Value RAM WATCHDOG limits for the Temperature reading that affect the $\overline{\text{INT}}$ and $\overline{\text{OS}}$ outputs of the LM96080. They are: T_{hot} , T_{hot} , T_{os} , and T_{os} hyst Limit Registers (addresses 38h - 3Bh). There are three interrupt modes of operation: "Default Interrupt" mode, "One-Time Interrupt" mode, and "Comparator Mode". The $\overline{\text{OS}}$ output of the LM96080 can be programmed for "One-Time Interrupt" mode and "Comparator" mode. $\overline{\text{INT}}$ can be programmed for "Default Interrupt" mode and "One-Time" Interrupt. These modes are explained below and shown in Figure 21.

"Default Interrupt mode" operates in the following way: Exceeding T_{hot} causes an Interrupt that will remain active indefinitely until reset by reading Interrupt Status Register 1 (address 01h) or cleared by the INT_Clear bit in the Configuration register (address 00h, bit 3). Once an Interrupt event has occurred by crossing T_{hot} , then reset, an Interrupt will occur again once the next temperature conversion has completed. The interrupts will continue to occur in this manner until the temperature goes below T_{hot} hyst, at which time the Interrupt output will automatically clear.

"One-Time Interrupt" mode operates in the following way: Exceeding T_{hot} causes an Interrupt that will remain active indefinitely until reset by reading Interrupt Status Register 1 or cleared by the INT_Clear bit in the Configuration register. Once an Interrupt event has occurred by crossing T_{hot} , then reset, an Interrupt will not occur again until the temperature goes below T_{hot} hyst.

"Comparator" mode operates in the following way: Exceeding T_{os} causes the \overline{OS} output to go Low (default). \overline{OS} will remain Low until the temperature goes below $T_{os\ hyst}$. Once the temperature goes below $T_{os\ hyst}$, \overline{OS} will go high.



A. This diagram does not reflect all the possible variations in the operation of the \overline{OS} and \overline{INT} outputs nor the \overline{OS} and Hot Temp bits. The interrupt outputs are cleared by reading the appropriate Interrupt Status Registers (addresses 01h - 02h).

Figure 21. Temperature Interrupt Response Diagram



THE LM96080 INTERRUPT STRUCTURE

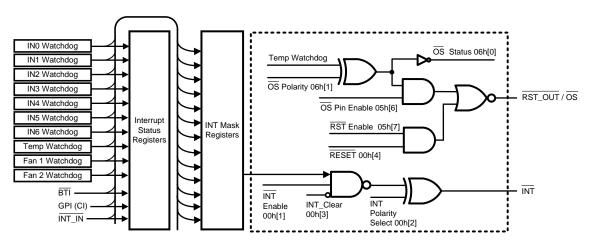


Figure 22. Interrupt Structure

Figure 22 depicts the Interrupt Structure of the LM96080. Note that the number next to each input of the gate represents a register and bit address. For example, INT_Clear 00h[3] refers to bit 3, INT_Clear, of register address 00h. The LM96080 can generate Interrupts as a result of each of its internal WATCHDOG registers on the analog, temperature, and fan inputs.

Interrupt Inputs

External Interrupts can come from the following sources. While the label suggests a specific type or source of Interrupt, this label is not a restriction of its usage, and it could come from any desired source:

- BTI (Board Temperature Interrupt) This is an active low Interrupt intended to come from the Overtemperature Shutdown (O.S.) output of LM75 temperature sensors. The LM75 O.S. output goes active when its temperature exceeds a programmed threshold. Up to 8 LM75's can be connected to a single serial bus with their O.S. output's wire or'ed to the BTI input of the LM96080. If the temperature of any LM75 exceeds its programmed limit, BTI is driven low. This generates an Interrupt via bit 1 of the Interrupt Status Register 2 (address 02h) to notify the host of a possible overtemperature condition. To disable this feature, set bit 1 of the Interrupt Mask Register 2 (address 04h) high. This pin also provides an internal pull-up resistor of 10 kΩ.
- **GPI (Chassis Intrusion)** This is an active high interrupt from any type of device that detects and captures chassis intrusion violations. This could be accomplished mechanically, optically, or electrically, and circuitry external to the LM96080 is expected to latch the event. Read this Interrupt using bit 4 of the Interrupt Status Register 2 (address 02h), and disable it using bit 4 of the Interrupt Mask Register 2 (address 04h). The design of the LM96080 allows this input to go high even with no power applied to the LM96080, and no clamping or other interference with the line will occur. This line can also be pulled low for at least 10 ms by the LM96080 to reset a typical Chassis Intrusion circuit. Accomplish this reset by setting bit 5 of Configuration Register (address 00h) high; this bit is self-clearing.
- INT_IN This active low Interrupt provides a way to chain the INT (Interrupt) from other devices through the LM96080 to the processor. If this pin is pulled low, then bit 7 of the Interrupt Status Register 1 (address 01h) will go high indicating this Interrupt detection. Setting bit 1 of the Configuration Register (address 00h) will also allow the output INT pin to go low when INT_IN goes low. To disable this feature, set bit 7 of the Interrupt Mask Register 1 (address 03h) high.

Interrupt Outputs

All Interrupts are indicated in the two Interrupt Status Registers.

- INT -an output pin, not to be confused with the input INT_IN pin. This pin becomes active whenever INT_IN, BTI, or GPI interrupts. As described in Using the Configuration Register, INT is enabled when bit 1 of the Configuration Register (address 00h) is set high. Bits 2 and 3 of the Configuration Register are also used to set the polarity and state of the INT Interrupt line.
- OS -dedicated to the Temperature reading WATCHDOG. In the Fan Divisor/RST OUT/OS Register (address)



OSh), the OS enable bit (bit 6), must be set high and the RST enable bit (bit 7) must be set low to enable the OS function on the RST_OUT/OS pin. OS pin has two modes of operation: "One-Time Interrupt" and "Comparator". "One-Time Interrupt" mode is selected by taking bit 2 of the OS Configuration/Temperature Resolution Register (address 06h) high. If bit 2 is taken low, "Comparator" mode is selected. Unlike the OS pin, the OS bit in Interrupt Status Register 2 (address 02h, bit 5) functions in "Default Interrupt" and "One-Time Interrupt" modes. The OS bit can be masked to INT pin by taking bit 5 in the Interrupt Mask Register 2 (address 04h) low. A description of "Comparator", "Default Interrupt", and "One-Time Interrupt" modes can be found in Temperature Data Format.

Interrupt Clearing

Reading an Interrupt Status Registers (addresses 01h - 02h) will output the contents of the Register and reset the Register. The Interrupt Status Registers clear upon being read. When the Interrupt Status Registers clear, the INT output pin is also cleared until the Registers are updated by the monitoring loop. The INT output pin is cleared with the INT_Clear bit (address 00h, bit 3), without affecting the contents of the Interrupt Status Registers. When this bit is high, the LM96080 monitoring loop will stop and will resume when the bit is low.

RST OUT and GPO OUTPUTS

In PC applications, the open drain $\overline{\text{GPO}}$ provides a gate drive signal to an external PMOS power switch. This external MOSFET would keep the power turned on regardless of the state of the front panel power switches when software power control is used. In any given application, this signal is not limited to the function described by its label. For example, since the LM96080 incorporates temperature sensing, the $\overline{\text{GPO}}$ output could also be utilized to control power to a cooling fan. Take $\overline{\text{GPO}}$ active low by setting bit 6 in the Configuration Register (address 00h) high.

RST_OUT is intended to provide a master reset to devices connected to this line. RST Enable, bit 7 of address 05h, is the RST_OUT/OS control bit that must be set high to enable this function. Setting bit 4, RESET, in the Configuration Register (address 00h) high outputs a low pulse of at least 10 ms on this line, at the end of which bit 4 in the Configuration Register automatically clears. Again, the label for this pin is only its suggested use. In applications where the RST_OUT capability is not needed, it can be used for any type of digital control that requires a 10 ms active low open drain output.

NAND TREE TESTS

A NAND tree is provided in the LM96080 for Automated Test Equipment (ATE) board level connectivity testing. If the user applies a logic zero to the NTEST_IN/Reset_IN input pin, the device will be in the NAND tree test mode. A0/NTEST_OUT will become the NAND tree output pin. To perform a NAND tree test, all pins included in the NAND tree should be driven to 1. Beginning with INO and working clockwise around the chip, each pin can be toggled and a resulting toggle can be observed on A0/NTEST_OUT. The following pins are excluded from the NAND tree test: GNDA (analog ground), GND (digital ground), V⁺ (power supply), A0/NTEST_OUT, NTEST_IN/Reset_IN and RST_OUT/OS. Allow for a typical propagation delay of 500 ns.

REGISTERS AND RAM

Address Register

The bit designations for a register are as follows:

| Bit | Name | Read/Write | Description |
|-----|-----------------|------------|--|
| 7-0 | Address Pointer | Read/Write | Address of RAM and Registers. See the tables below for detail. |

| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-------|--|-------|-------|-------|-------|-------|-------|
| | Address Pointer (Power On default 00h) | | | | | | |
| A7 | A6 | A5 | A4 | А3 | A2 | A1 | A0 |



Address Pointer Index (A7-A0)

| Registers and RAM | A7-A0 in Hex | Power On Value of Registers: <7:0> in Binary |
|--|--------------|--|
| Configuration Register | 00h | 0000 1000 |
| Interrupt Status Register 1 | 01h | 0000 0000 |
| Interrupt Status Register 2 | 02h | 0000 0000 |
| Interrupt Mask Register 1 | 03h | 0000 0000 |
| Interrupt Mask Register 2 | 04h | 0000 0000 |
| Fan Divisor/RST_OUT/OS | 05h | 0001 0100 |
| OS Configuration/Temperature Resolution Register | 06h | 0000 0001 |
| Conversion Rate Register | 07h | 0000 0000 |
| Channel Disable Register | 08h | 0000 0000 |
| Value RAM | 20h – 3Fh | Register 3Eh defaults to 0000 0001 Register 3Fh defaults to 0000 1000 |

Configuration Register—Address 00h

Power on default <7:0> = 00001000 binary

| Bit | Name | Read/Write | Description |
|-----|------------------------|------------|--|
| 0 | Start | Read/Write | A one enables startup of monitoring operations, a zero puts the part in shutdown mode. Note: Unlike the "INT_Clear" bit, the outputs of Interrupt pins will not be cleared if the user writes a zero to this location after an interrupt has occurred. At startup, limit checking functions and scanning begin. Note, all limits should be set in the Value RAM before setting this bit HIGH. |
| 1 | INT Enable | Read/Write | A one enables the INT Interrupt output. |
| 2 | INT Polarity Select | Read/Write | A one selects an active high open source output while a zero selects an active low open drain output. |
| 3 | INT_Clear | Read/Write | A one disables the $\overline{\text{INT}}$ output without affecting the contents of Interrupt Status Registers. The device will stop monitoring. It will resume upon clearing of this bit. |
| 4 | RESET | Read/Write | A one outputs at least a 10 ms active low reset signal at RST_OUT, if bit 7 and bit 6 in the Fan Divisor/RST_OUT/OS Register (address 05h) = 1 and = 0, respectively. This bit is cleared once the pulse has gone inactive. |
| 5 | Chassis Clear | Read/Write | A one clears the GPI (Chassis Intrusion) pin. This bit clears itself after 10 ms. |
| 6 | GPO | Read/Write | A one drives the GPO (General Purpose Output) pin low. |
| 7 | INITIALIZATION | Read/Write | A one restores power on default value to the Configuration Register, Interrupt Status Registers, Interrupt Mask Registers, Fan Divisor/RST_OUT/OS Register, the OS Configuration/Temperature Resolution Register, Conversion Rate, Channel Disable, Manufacturers ID and Stepping/Die revision ID registers. This bit clears itself. The power-on default is zero. |

Interrupt Status Register 1—Address 01h

Power on default <7:0> = 0000 0000 binary

| Bit | Name | Read/Write | Description |
|-----|--------|------------|---|
| 0 | IN0 | Read Only | A one indicates a High or Low limit has been exceeded. |
| 1 | IN1 | Read Only | A one indicates a High or Low limit has been exceeded. |
| 2 | IN2 | Read Only | A one indicates a High or Low limit has been exceeded. |
| 3 | IN3 | Read Only | A one indicates a High or Low limit has been exceeded. |
| 4 | IN4 | Read Only | A one indicates a High or Low limit has been exceeded. |
| 5 | IN5 | Read Only | A one indicates a High or Low limit has been exceeded. |
| 6 | IN6 | Read Only | A one indicates a High or Low limit has been exceeded. |
| 7 | INT_IN | Read Only | A one indicates that a Low has been detected on the INT_IN. |



Interrupt Status Register 2—Address 02h

Power on default <7:0> = 0000 0000 binary

| Bit | Name | Read/Write | Description |
|-----|----------------------------|------------|--|
| 0 | Hot Temperature | Read Only | A one indicates a High or Low limit has been exceeded. Only "One-Time Interrupt" and "Default Interrupt" modes are supported (see Temperature Interrupts and Interrupt Outputs). The mode is set by bit-6 of the Interrupt Mask Register 2 (address 04h). |
| 1 | BTI | Read Only | A one indicates that an interrupt has occurred from the Board Temperature Interrupt (BTI) input pin. BTI can be tied to the OS output of multiple LM75 chips. |
| 2 | FAN1 | Read Only | A one indicates that a fan count limit has been exceeded. |
| 3 | FAN2 | Read Only | A one indicates that a fan count limit has been exceeded. |
| 4 | GPI (Chassis Intrusion) | Read Only | A one indicates GPI (Chassis Intrusion) has gone high. |
| 5 | OS bit | Read Only | A one indicates a High or a Low $\overline{\text{OS}}$ Temperature limit has been exceed. Only "One-Time Interrupt" and "Default Interrupt" modes are supported (see Temperature Interrupts and Interrupt Outputs). The mode is set by bit 7 of the Interrupt Mask Register 2. |
| 6 | Reserved | Read Only | |
| 7 | Reserved | Read Only | |

Interrupt Mask Register 1—Address 03h

Power on default <7:0> = 0000 0000 binary

| Bit | Name | Read/Write | Description |
|-----|--------|------------|--|
| 0 | IN0 | Read/Write | A one disables the corresponding interrupt status bit for $\overline{\text{INT}}$ interrupt. |
| 1 | IN1 | Read/Write | A one disables the corresponding interrupt status bit for $\overline{\text{INT}}$ interrupt. |
| 2 | IN2 | Read/Write | A one disables the corresponding interrupt status bit for INT interrupt. |
| 3 | IN3 | Read/Write | A one disables the corresponding interrupt status bit for $\overline{\text{INT}}$ interrupt. |
| 4 | IN4 | Read/Write | A one disables the corresponding interrupt status bit for $\overline{\text{INT}}$ interrupt. |
| 5 | IN5 | Read/Write | A one disables the corresponding interrupt status bit for $\overline{\text{INT}}$ interrupt. |
| 6 | IN6 | Read/Write | A one disables the corresponding interrupt status bit for $\overline{\text{INT}}$ interrupt. |
| 7 | INT_IN | Read/Write | A one disables the corresponding interrupt status bit for INT interrupt. |

Interrupt Mask Register 2—Address 04h

Power on default <7:0> = 0000 0000 binary

| Bit | Name | Read/Write | Description |
|-----|---|------------|--|
| 0 | Hot Temperature | Read/Write | A one disables the corresponding interrupt status bit for $\overline{\text{INT}}$ interrupt. |
| 1 | BTI | Read/Write | A one disables the corresponding interrupt status bit for $\overline{\text{INT}}$ interrupt. |
| 2 | FAN1 | Read/Write | A one disables the corresponding interrupt status bit for $\overline{\text{INT}}$ interrupt. |
| 3 | FAN2 | Read/Write | A one disables the corresponding interrupt status bit for $\overline{\text{INT}}$ interrupt. |
| 4 | GPI (Chassis Intrusion) | Read/Write | A one disables the corresponding interrupt status bit for \overline{INT} interrupt. |
| 5 | OS bit | Read/Write | A one disables the corresponding interrupt status bit for $\overline{\text{INT}}$ interrupt. |
| 6 | Hot Temperature Interrupt Mode Select | Read/Write | A zero selects the default interrupt mode which gives the user an interrupt if the temperature goes above the hot limit. The interrupt will be cleared once the status register is read, but it will again be generated when the next conversion has completed. It will continue to do so until the temperature goes below the hysteresis limit. |
| | | | A one selects the one time interrupt mode which only gives the user one interrupt when it goes above the hot limit. The interrupt will be cleared once the status register is read. Another interrupt will not be generated until the temperature goes below the hysteresis limit. It will also be cleared if the status register is read. No more interrupts will be generated until the temperature goes above the hot limit again. The corresponding bit will be cleared in the status register every time it is read but may not set again when the next conversion is done. (Refer to Figure 21). |



| Bit | Name | Read/Write | Description |
|-----|---------------------------------|------------|--|
| 7 | OS Bit Interrupt Mode Select | Read/Write | A zero selects the default interrupt mode which gives the user an interrupt if the temperature goes above the OS limit. The interrupt will be cleared once the status register is read, but it will again be generated when the next conversion has completed. It will continue to do so until the temperature goes below the hysteresis limit. |
| | | | A one selects the one time interrupt mode which only gives the user one interrupt when it goes above the OS limit. The interrupt will be cleared once the status register is read. Another interrupt will not be generated until the temperature goes below the hysteresis limit. It will also be cleared if the status register is read. No more interrupts will be generated until the temperature goes above the OS limit again. The corresponding bit will be cleared in the status register every time it is read but may not set again when the next conversion is done. (Refer to Figure 21). |

Fan Divisor/RST_OUT/OS Register —Address 05h

Power on - <7:0> is 0001 0100

| Bit | Name | Read/Write | Description |
|-----|------------------|------------|---|
| 0 | FAN1 Mode Select | Read/Write | A one selects the level sensitive input mode while a zero selects Fan count mode for the FAN1 input pin. |
| 1 | FAN2 Mode Select | Read/Write | A one selects the level sensitive input mode while a zero selects Fan count mode for the FAN2 input pin. |
| 2-3 | FAN1 RPM Control | Read/Write | FAN1 Speed Control. |
| | | | <3:2> = 00 - divide by 1; |
| | | | <3:2> = 01 - divide by 2; |
| | | | <3:2> = 10 - divide by 4; |
| | | | <3:2> = 11 - divide by 8. |
| | | | If level sensitive input is selected: <2> = 1 selects and active-low input (An interrupt will be generated if the FAN1 input is Low), <2> = 0 selects an active-high input (an interrupt will be generated if the FAN1 input is High). |
| 4-5 | FAN2 RPM Control | Read/Write | FAN2 Speed Control. |
| | | | <5:4> = 00 - divide by 1; |
| | | | <5:4> = 01 - divide by 2; |
| | | | <5:4> = 10 - divide by 4; |
| | | | <5:4> = 11 - divide by 8. |
| | | | If level sensitive input is selected: <4> = 1 selects and active-low input (An interrupt will be generated if the FAN2 input is Low), <4> = 0 selects an active-high input (an interrupt will be generated if the FAN2 input is High). |
| 6 | OS Pin Enable | Read/Write | A one enables $\overline{\text{OS}}$ mode on the $\overline{\text{RST_OUT/OS}}$ output $\overline{\text{pin}}$, while $\overline{\text{bit 7}}$ of this register is set to zero. If $\overline{\text{bits 6}}$ and 7 of this register are set to zero, the $\overline{\text{RST_OUT/OS}}$ pin is disabled. |
| 7 | RST Enable | Read/Write | A one sets the RST_OUT/OS pin in the RST_OUT mode instead of the OS mode. If bits 6 and 7 of this register are set to zero, the RST_OUT/OS pin is disabled. |

OS Configuration/Temperature Resolution Register—Address 06h

Power on default <7:0> = 0000 0001 binary

| Bit | Name | Read/Write | Description |
|-----|-----------------------------------|------------|--|
| 0 | OS Status | Read only | Status of the $\overline{\text{OS}}$. This bit mirrors the state of the $\overline{\text{RST_OUT/OS}}$ pin when in the $\overline{\text{OS}}$ mode. |
| 1 | OS Polarity | Read/Write | A zero selects $\overline{\text{OS}}$ to be active-low, while a one selects $\overline{\text{OS}}$ to be active high. $\overline{\text{OS}}$ is an opendrain output. |
| 2 | OS Mode Select | Read/Write | A one selects the one time interrupt mode for $\overline{\text{OS}}$, while a zero selects comparator mode for $\overline{\text{OS}}$. (See Temperature Data Format) |
| 3 | Temperature Resolution Control | Read/Write | A zero selects the default 8-bit plus sign resolution temperature conversions, while a one selects 11-bit plus sign resolution temperature conversions. |



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| Bit | Name | Read/Write | Description |
|-----|------------|------------|---|
| 4-7 | Temp [3:0] | Read/Write | The lower nibble (4 LSbs) of the 11-bit plus sign temperature data: <4> = Temp [0] (nibble LSb, 0.0625°C), <5> = Temp [1], <6> = Temp [2], <7> = Temp [3] (nibble MSb, 0.5°C). For 8-bit plus sign temperature resolution: <7> = Temp [0] (LSb, 0.5°C) <4:6> are undefined |

Conversion Rate Register—Address 07h

Power on default <7:0> = 0000 0000 binary

| Bit | Name | Read/Write | Description |
|-----|----------|------------|--|
| 0 | CR1 | Read/Write | Controls conversion rate: 0 = 728ms (typical) 1 = Continuous Conversion. Note: — Each voltage channel conversion takes 3 ms typical. — Temperature conversion takes 3.6 ms typical for 9 - bit resolution and 23.5 ms typical for 12 - bit resolution. — Each fan tachometer input is monitored for 2 pulses, the time interval for two pulses is added to the round robin time for each fan tach input that is enabled. |
| 1-7 | Reserved | Read only | Reserved — will always report zero. |

Voltage/Temperature Channel Disable Register—Address 08h

Power on default <7:0> = 0000 0000 binary

| Bit | Name | Read/Write | Description |
|-----|------|------------|--|
| 0 | INO | Read/Write | When set to "1", IN0: conversions are skipped and disabled value register reading will be 0 error events will be suppressed |
| 1 | IN1 | Read/Write | When set to "1", IN1: conversions are skipped and disabled value register reading will be 0 error events will be suppressed |
| 2 | IN2 | Read/Write | When set to "1", IN2: conversions are skipped and disabled value register reading will be 0 error events will be suppressed |
| 3 | IN3 | Read/Write | When set to "1", IN3: conversions are skipped and disabled value register reading will be 0 error events will be suppressed |
| 4 | IN4 | Read/Write | When set to "1", IN4: conversions are skipped and disabled value register reading will be 0 error events will be suppressed |
| 5 | IN5 | Read/Write | When set to "1", IN5: conversions are skipped and disabled value register reading will be 0 error events will be suppressed |
| 6 | IN6 | Read/Write | When set to "1", IN6: conversions are skipped and disabled value register reading will be 0 error events will be suppressed |
| 7 | Temp | Read/Write | When set to "1", Temperature: conversions are skipped and disabled value register readings will be 0 error events will be suppressed |



Value RAM—Address 20h-3Fh⁽¹⁾

| Address A7-A0 | Description |
|---------------|---|
| 20h | IN0 reading (10-bit) |
| 21h | IN1 reading (10-bit) |
| 22h | IN2 reading (10-bit) |
| 23h | IN3 reading (10-bit) |
| 24h | IN4 reading (10-bit) |
| 25h | IN5 reading (10-bit) |
| 26h | IN6 reading (10-bit) |
| 27h | Temperature reading (9-bit or 12-bit for easy read-back) |
| 28h | FAN1 reading Note: This location stores the number of counts of the internal clock per revolution. |
| 29h | FAN2 reading Note: This location stores the number of counts of the internal clock per revolution. |
| 2Ah | IN0 High Limit |
| 2Bh | IN0 Low Limit |
| 2Ch | IN1 High Limit |
| 2Dh | IN1 Low Limit |
| 2Eh | IN2 High Limit |
| 2Fh | IN2 Low Limit |
| 30h | IN3 High Limit |
| 31h | IN3 Low Limit |
| 32h | IN4 High Limit |
| 33h | IN4 Low Limit |
| 34h | IN5 High Limit |
| 35h | IN5 Low Limit |
| 36h | IN6 High Limit |
| 37h | IN6 Low Limit |
| 38h | Hot Temperature Limit (High) |
| 39h | Hot Temperature Hysteresis Limit (Low) |
| 3Ah | OS Temperature Limit (High) |
| 3Bh | OS Temperature Hysteresis Limit (Low) |
| 3Ch | FAN1 Fan Count Limit Note: It is the number of counts of the internal clock for the Low Limit of the fan speed. |
| 3Dh | FAN2 Fan Count Limit Note: It is the number of counts of the internal clock for the Low Limit of the fan speed. |
| 3Eh | Manufacturer's ID always defaults to 0000 0001; this register is writable and can be reset to the default value by the INITIALIZATION bit in the Configuration Register (address 00h, bit 7). |
| 3Fh | Stepping/Die Revision ID always defaults to 0000 1000; this register is writable and can be reset to the default value by the INITIALIZATION bit in the Configuration Register. |

⁽¹⁾ Setting all ones to the high limits for voltages and fans (0111 1111 binary for temperature) means interrupts will **never** be generated except the case when voltages go below the low limits.

For voltage input high limits, the device is doing a greater than comparison. For low limits, however, it is doing a less than or equal to comparison.





REVISION HISTORY

| Cł | Changes from Revision C (March 2013) to Revision D | | | | | | |
|----|--|--|----|--|--|--|--|
| • | Changed layout of National Data Sheet to TI format | | 28 | | | | |

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PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|-------------------|--------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|----------------------|---------|
| | | | | | | | (6) | | | | |
| LM96080CIMTX/NOPB | ACTIVE | TSSOP | PW | 24 | 2500 | RoHS & Green | SN | Level-1-260C-UNLIM | -40 to 125 | LM96080 CIMT | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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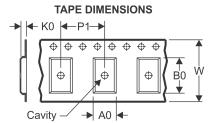
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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

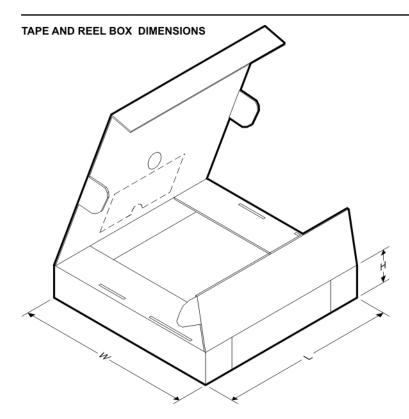
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| LM96080CIMTX/NOPB | TSSOP | PW | 24 | 2500 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |

www.ti.com 5-Jan-2022



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LM96080CIMTX/NOPB | TSSOP | PW | 24 | 2500 | 367.0 | 367.0 | 35.0 |

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

| Device Package Name | | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|---------------------|----|--------------|------|-----|--------|--------|--------|--------|
| LM96080CIMT/NOPB | PW | TSSOP | 24 | 61 | 495 | 8 | 2514.6 | 4.06 |



SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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